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By Erdogan Madenci

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<http://www.dfrsolutions.com/calculators/solder-joint-fatigue/>

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18 LIFE PREDICTION OF SOLDER JOINTS [see Gustafsson et al. (2000) for a comparison of the techniques]. These common modeling techniques can be classified into five

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Abstract: A computational study is presented in this paper to investigate the effect of variation in material properties on the fatigue life prediction of solder

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Thermal Fatigue Life Prediction of Gull-Wing -

A nonlinear, time-dependent finite element modeling analysis has been performed to determine the strain distribution in gull-wing solder joints and to predict the

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